NSN 5962-01-247-5647

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View Online at https://aerobasegroup.com/nsn/5962-01-247-5647

Body Length:

Between 0.540 inches and 0.560 inches

Body Width:

Between 0.442 inches and 0.458 inches

Body Height:

Between 0.060 inches and 0.120 inches

Maximum Power Dissipation Rating:

170.0 milliwatts

Operating Tempurature Range:

-55.0/+125.0 degrees celsius

Storage Tempurature Range:

-65.0/+150.0 degrees celsius

End Application:

6660-01-153-1269 cloud height se

Features Provided:

Programmable and monolithic and ultraviolet erasable and high speed

Inclosure Material:

Ceramic and glass

Inclosure Configuration:

Leadless flat pack

Output Logic Form:

Complementary-metal oxide-semiconductor logic

Input Circuit Pattern:

17 input

Case Outline Source And Designator:

C-12 mil-m-38510

Terminal Surface Treatment:

Solder

Voltage Rating And Type Per Characteristic:

-2.0 volts power source and 7.0 volts power source

Memory Device Type:

Rom

Test Data Document:

96906-mil-std-883 standard (includes industry or association standards, individual manufactureer standards, etc.).

Terminal Type And Quantity:

32 leadless

Shelf Life:

N/a

Unit Of Measure:

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Demilitarization:

Yes - demil/mli

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